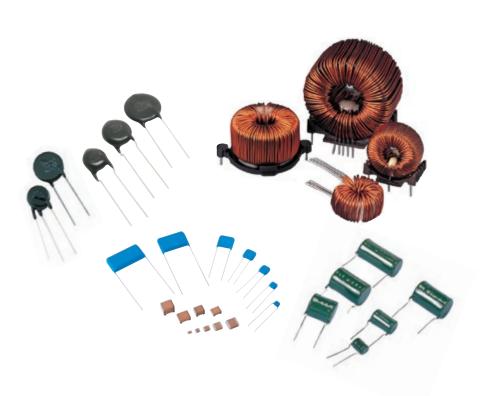
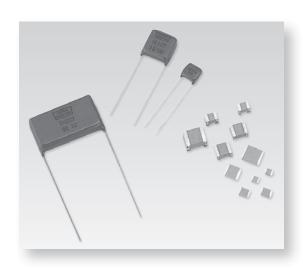


2018

CERAMIC CAPACITORS VARISTORS FILM CAPACITORS CHOKE COILS

CAT.NO.E1002X / E1006A / E1003U / E1008S





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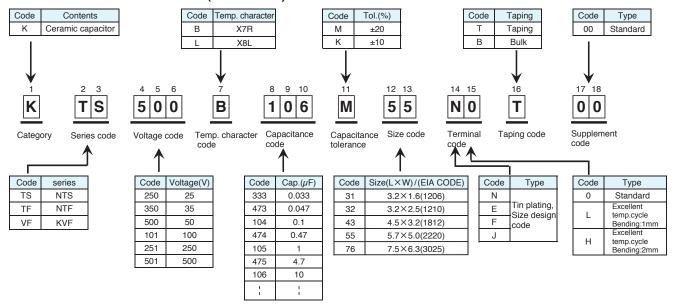


Item	Series	Rated Voltage Range (Vdc)	Rated Capacitance Range(µF)	Temperature Characteristics	RoHS2 Compliant	Page
Chip Type	NTS	25 to 500	0.010 to 47	X7R : -55∼+125°C		13
Chip Type	NTF	25 to 500	0.033 to 33	0.033 to 33 △C/C 25°C=±15%		15
Chip Type	KVF	25 to 100	0.033 to 15	X8L:-55~+125°C ΔC/C 25°C=±15% +125~+150°C ΔC/C 25°C=+15%,-40%	Compliant	19
Metal cap Type	NTJ	25 to 250	1.0 to 100	X7R : -55∼+125°C	Compilant	22
Lead Type	NTD	25 to 500	0.1 to 470	ΔC/C 25°C=±15%		25
Lead Type	KVD	25 to 100	0.1 to 15	X8L:-55~+125°C ΔC/C 25°C=±15% +125~+150°C ΔC/C 25°C=+15%,-40%		29

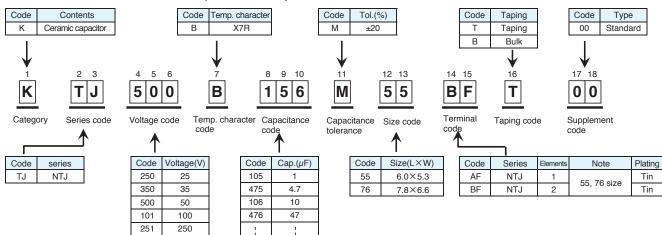


Part Numbering System

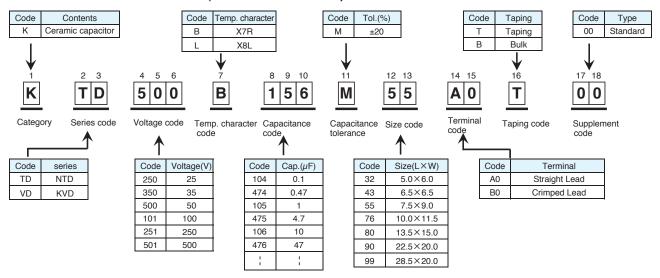
◆ PART NUMBERING SYSTEM (CHIP TYPE)



◆ PART NUMBERING SYSTEM (METAL CAP)

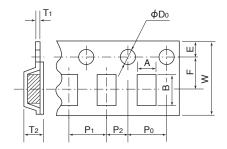


◆ PART NUMBERING SYSTEM (RADIAL LEAD TYPE)





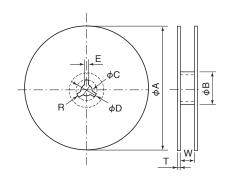
♦CHIP TYPE TAPING SPECIFICATION



						Dime	nsions	(mm)				
Туре	Size Code	Α*	В*	W ±0.3	F ±0.05	E ±0.1	P ₁ ±0.1	P ₂ ±0.05	Po ±0.1	φD ±0.1	T ₁ max.	T ₂ max.
	31	1.9	3.5	8.0	3.5	1.75	4.0	2.0	4.0	1.5	0.6	1.5
	32	2.8	3.5	8.0	3.5	1.75	4.0	2.0	4.0	1.5	0.6	2.5
Chip type	43	3.65	4.95	12.0	5.5	1.75	8.0	2.0	4.0	1.5	0.6	3.5
type	55	5.5	6.25	12.0	5.5	1.75	8.0	2.0	4.0	1.5	0.6	3.5
	76	6.85	8.05	16.0	7.5	1.75	12.0	2.0	4.0	1.5	0.6	5.5
	55	5.3	6.4	16.0	7.5	1.75	8.0	2.0	4.0	1.5	0.6	6.0
Metal		6.9	8.2	16.0	7.5	1.75	12.0	2.0	4.0	1.5	0.6	7.5
cap type	76	6.9	8.2	24.0	11.5	1.75	24.0	2.0	4.0	1.5	0.4	8.5
		6.9	8.2	32.0	14.2	1.75	24.0	2.0	4.0	1.5	0.5	10.0

*Reference

•REEL SPECIFICATIONS



Size	Dimensions (mm)									
Code	N	TS, NTF, KV	F	NTJ						
Code	31, 32	43, 55	76	55, 76	7	6				
φА	178±2	178±2	178±2	382±2	382±2	382±2				
φВ	50min.	50min.	50min.	80min.	80min.	80min.				
φС	13±0.5	13±0.5	13±0.5	13±0.5	13±0.5	13±0.5				
φD	21±0.8	21±0.8	21±0.8	21±0.8	21±0.8	21±0.8				
Е	2±0.5	2±0.5	2±0.5	2±0.5	2±0.5	2±0.5				
W	9±0.5	13±0.5	17±0.5	17±0.5	25±0.5	33±0.5				
Т	1±0.5	1±0.5	1±0.5	2±0.5	2±0.5	2±0.5				
R	1.0	1.0	1.0	1.0	1.0	1.0				

NTS, NTF, KVF Series quantity per reel (pcs. / reel)

Size Code	31	32	43	55	76
Quantity	3000	1600	800	800	300/500

Note: Refer to STANDARD RATINGS

NTJ Series quantity per reel (pcs. / reel)

Size Code	55	76
Quantity	400/2000	400/500/1200

Note: Refer to STANDARD RATINGS

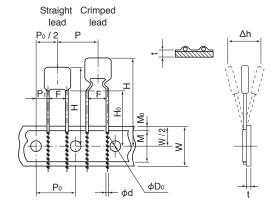
◆RADIAL LEAD TYPE TAPING SPECIFICATION

NTD, KVD Series

Available for 32, 43, 55, 76 sizes. Ammo Packaging.

Siza Cada	Dimensio	ons H (mm)	Quantity per Packing
Size Code	Straight lead	Crimped lead	(pcs.)
32	23max.	25max.	
43	24max.	26max.	2000
55	26max.	28max.	
76	29max.	30max.	1000/1500

Note: Refer to STANDARD RATINGS



														(mm)
Code	Р	Po	P ₁	P ₀ /2	F	W	W/2	М	Mo	Н₀	φDo	φd	t	Δh
	12.7	12.7	3.85	6.35	5.0	18.0	9.0	13.0	1.5	16.0	4.0	0.5	0.6	0
Dimensions (mm)	±1	±0.3	±0.7	±1.3	+0.8 -0.2	+1.0 -0.5	±0.5	±1	±1.5	min.	±0.2	±0.05	±0.2	±2



Minimum Packaging Quantity

Please order by units of minimum packaging quantity.

♦ Chip

Series	Size code	Elements	Rated voltage (V _{dc})	Rated Capacitance (µF)	Taping (pcs.)	Tray (pcs. / box)	Bagged (pcs. / box)
	31	-	All Voltaç	ge Range	3,000	-	9,000
NITO NITE IZVE	32 -		All Voltage Range		1,600	-	6,000
NTS, NTF, KVF	43	-	All Voltage Range		800	-	3,000
	55	-	All Voltaç	ge Range	800	-	1,500
			500	0.68	500	-	1,500
NTS	76	-	Rating other than the above		300	-	1,500

◆ Metal Cap

Series	Size code	Elements	Rated voltage (V _{dc})	Rated Capacitance (µF)	Taping (pcs.)	Tray (pcs. / box)	Bagged (pcs. / box)		
	55	EE	EE	1	All Voltag	ge Range	400	800	-
		2	All Voltage Range		2,000	800	-		
NTJ		1	All Voltage Range		1,200	800	-		
1410	76	6	25	100	400	800	-		
	70	2	All rating other than the above		500	800	-		

♦ Radial Lead

Series	Size code	Elements	Rated voltage (V _{dc})	Rated Capacitance (µF)	Taping (pcs.)	Tray (pcs. / box)	Bagged (pcs. / box)
	32	-	All Voltaç	ge Range	2,000	-	2,000
	43	-	All Voltaç	ge Range	2,000	-	2,000
	55	55 -		All Voltage Range		-	2,000
		76 -	500	0.68	1,500	-	500
			500	1.0	1,500	-	500
NTD, KVD	76		500	1.2	1,500		500
			Rating other than the above		1,000	-	500
	80		All Voltaç	ge Range	-	100	-
	90	-	All Voltaç	ge Range	-	60	-
	99	-	All Voltaç	ge Range	-	50	-

CAT. No. E1002X

1 In designing device circuits

- (1) Confirming the installation and operating environment of capacitors, use them within the rated performance limits prescribed in their catalog or product specifications. Otherwise, excessive use conditions cause the capacitors to have catastrophic failure such as short circuit, open circuit or firing.
- (2) Do not apply a DC voltage which exceeds the full rated voltage. The peak voltage of a superimposed AC voltage (ripple voltage) on the DC voltage must not exceed the full rated voltage.
- (3) By considering the temperature characteristic and the DC bias characteristic of the ceramic capacitors, please determine the right capacitance. The capacitance of the capacitors changes in low and high temperature ambiences and depends on the applied bias voltages. The capacitance change (i.e. reduction) may affect the performance of the circuit which is containing the capacitors. Therefore, please examine the capacitors in the actual operational conditions to verify that they are right ones.
- (4) The common failure mode of multilayer ceramic capacitors is contingent insulation breakdown or short circuit. When the capacitors are used in a high-power circuit, they may damage the surroundings of the capacitors when failed. Therefore, the high-power circuit should have protective device/protective devices to shut down the circuit from the capacitor/capacitors. The reliability of the capacitors improves when the ambient temperatures are in the normal temperature range and the applied voltages are low.
- (5) When large high frequency ripple current acrosses multilayer ceramic capacitor, the capacitor can vibrate. The phenomenon occurs as the capacitor, has natural vibration frequency due to the mechanical dimensions, resonates to the large high frequency ripple current.

To prevent the resonance, please select the capacitor or change the ripple current frequency. For your information, we indicate the following resonance frequency to each chip size.

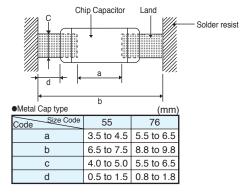
Size Code	Chip Size	(kHz)
31	3.2× 1.6	650, 1200, 1600
32	3.2× 2.5	650, 850, 1200
43	4.5× 3.2	450, 650, 1200
55	5.7× 5.0	350, 450, 850
76	7.5× 6.3	350, 600, 750
80	10.0× 9.0	230, 320, 620
90	20.0×12.7	100, 170, 450
99	25.0×12.7	80 160 250

- (6) The capacitance of the capacitors depends on the ambient temperatures and bias voltages. Therefore, please examine the capacitors when they are to be used in a time-constant circuit before the use.
- (7) Consult us for devices that requires high reliability. For components which are used to the devices whose failure affects human life or causes social loss by serious damage, higher reliable designs than general purpose components are required.
- (8) Please contact us, when you use it for AC use.

2 In designing PC boards

- (1) Put the proper volume of solder (the size of fillet) on PC boards for installing surface mount capacitors, because it directly affects the installed capacitors. The design of copper pad patterns and dimensions should be set so that the proper volume of solder can be provided. The standard land dimensions are shown below.
- (2) Land width of PC boards shall not exceed the width of chip capacitors.

●Chip type										
Code Size Code	31	32	43	55	76					
а	2.2 to 2.5	2.2 to 2.5	3.5 to 3.7	4.5 to 4.7	5.0 to 5.2					
b	4.2 to 5.8	4.2 to 5.8	5.5 to 6.1	6.7 to 8.3	8.8 to 10.8					
С	1.2 to 1.6	1.8 to 2.5	2.3 to 3.2	3.5 to 5.0	4.7 to 6.3					
d	0.4 to 0.8	0.5 to 1.0	0.6 to 1.1	0.7 to 1.2	0.8 to 1.3					



- (3) When the multilayer ceramic capacitors are mounted on a substrate, the chips may crack when mechanical stress is put. Also, when the substrate is bent, they may also crack. Therefore, please make sure that the material and size of the substrate and the capacitor positions are right.
- (4) For a leaded capacitor, design the PC boards with the correct terminal hole space equal to the lead space of the capacitor.



MULTILAYER CERAMIC CAPACITORS PRECAUTIONS AND GUIDELINES

3 Installation

- (1) When installing leaded capacitors in the PC boards by means of an automatic insertion machine, minimize the mechanical shock applied to the capacitors by the lead clinch unit of the machine.
- (2) When the capacitors are to be mounted on a substrate, please minimize the shock and weight to the capacitor bodies. The nozzle pressure during the mounting process should be adjusted to 1N~3N maximum in static load.
- (3) Periodically maintain and inspect installation machines.
- (4) Where an adhesive is used to pre-anchor capacitors on PC boards, use appropriate copper pad dimensions, type of adhesive, coating volume, curing temperature and time, etc. to prevent the capacitors from deteriorating.

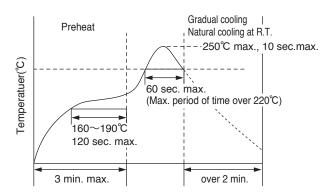
4 Soldering

- (1) Use flux with a halogen content of less than 0.1 wt. %. Do not use strong acid flux.
- (2) Minimize a volume of flux to coat the PC boards with.
- (3) Follow the soldering conditions prescribed in the catalog or product specifications. Excessive thermal stress affects the performance of the capacitors.
- (4) Note that surface mount capacitors with the size 3.2×1.6 or smaller tend to stand up during vapor phase reflow soldering.
- (5) For reflow soldering, place surface mount capacitors on the PC boards as soon as possible after solder paste was coated.
- (6) Please be aware that thermal deformation of substrates during mounting process cause stress to the substrates. Especially, substrates which are mounting chip capacitors are to be flow soldered to solder leaded parts or solder other parts onto the substrates, please make sure that the deformation during the soldering causes no harm. In fact, the deformation may cause stress to the substrates which leads to the capacitor element cracks/insulation-layer break down/insulation resistance degradation. The effect of the stress due to the deformation depends on the material of the substrates. Therefore, please be aware of the following information.
 - a) Ceramic substrates
 - The stress due to the deformation of ceramic substrates is thought be the minimum. Heat contract difference during solder hardening can be the effect to ceramic capacitors mounted on the substrates. So, please avoid forced cooling during the hardening.
 - b) Glass epoxy substrates
 - The stress due to the deformation and warp of glass epoxy substrates affects ceramic capacitors mounted. The stress depends on the size and material of the substrates, pattern positions and thermal gradient during soldering. Temperature difference between the both sides of the substrates may also cause the stress. When the material of the substrates, which are mounting ceramic capacitors, is FR-4 or the equivalent and other parts are to be flow soldered, the surface of the side with the capacitors shall be sufficiently preheated to 150°C or over before the flow soldering. During the soldering, the temperature difference between the side with the capacitors and the other side of the substrate should be 100℃ maximum.
 - c) Metal substrates
 - The deformation and warp of metal substrates considerably affect ceramic capacitors mounted. Therefore, please use metal caps which can moderate the stress of the substrates.
- (7) After reflow/flow soldering, please cool the PC boards which mounted capacitors naturally in the air.
- (8) Ceramic chip capacitors are solderable by twice maximum in reflow or flow soldering. When the capacitors are to be reflow soldered and then flow soldered, there shall be no additional soldering to the capacitors. However, the capacitors having a size of 5.7×5.0 or larger should be soldered by one time only.
- (9) Metal cap type capacitors (NTJ series) is two times reflow.
- (10) Due to the nature of ceramic, radical heating or cooling and partial heating may crack the ceramic capacitor element. Please have enough pre-heating process before soldering.
- (11)Ultrasonic cleaning time shall be ten minutes maximum.
 - When the power of ultrasonic cleaner is too high, the strength of terminations may drop.
 - Therefore, carefully examine the cleaning conditions before use.
- (12) Adjust the amount of solder cream in order that solder fillet shall be 1/2 to 2/3 height of chips. If fillet can confirm, size of 4.5×3.2 or larger is not this limit.
- (13) When more than two chips are mounted on a common land, please separate the chips by the solder resist.
- (14)In hand soldering, please take into consideration the following items.
 - 1. Fully pre-heat on a heating plate whose surface temperature is 100°C to 150°C.
 - 2. Soldering iron power shall not exceed 30W.
 - 3. Soldering iron tip diameter shall not exceed 3mm.
 - 4. Temperature of iron tip shall be adjusted to not exceed 300℃,3sec.
 - 5. The soldering iron tip shall not touch ceramic body directly.
 - 6. After soldering, let the products to be room temperature to cool gradually.

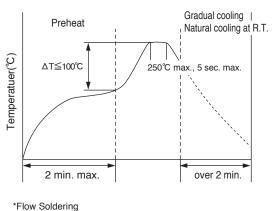
CAT. No. E1002X

5 Soldering profile

Reflow Soldering Profile



Flow Soldering Profile



Tin plating (Size code: 31, 32, 43)

6 Cleaning

- (1) In the case that the assembly boards are washed, choose the appropriate cleaning agent for the washing purpose.
- (2) To determine the cleaning conditions, make sure by means of the actual washing equipment that the performance of the capacitors is not affected.
- (3) In the case that water-soluble flux was used, sufficiently wash the assembly boards.

7 Coating materials

- (1) When ceramic capacitors are to be resin coated or molded, please pay enough attention. Ceramic capacitors molded in resin, and please do not use it. There is fear to destroy a capacitor by stress to occur by the expansion / the shrinkage when resin stiffens. When a thermal expansion shrinkage coefficient in hardening uses big resin, coating in the resin which is soft with capacitors, please make that stress is added to capacitors small as much as possible.
- (2) Confirm that harmful resolution or formation gasses are not generated from the coating materials during the curing process or by spontaneously leaving the coated assembly boards.
- (3) If a coating material is cured at higher temperatures than the Category temperature of the capacitor, the exterior resin will deteriorate resulting in the capacitor damage.

8 Handling

- (1) When cutting off a multi-board to make individual units, curving or twisting the board may crack the capacitors. Appropriate tools should be used to cut it off.
- (2) Excessive mechanical shock to capacitors or their assembly boards may make the capacitors crack.
- (3) Use leaded capacitors without bending their lead wires as much as possible.
- (4) When ceramic capacitors are stored with no load, the capacitance reduces during the storage (named "aging characteristic"). As for the product that capacitance decreased, capacity recovers in an initial value by heat-treating it.
- (5) When the electrodes of the ceramic capacitors are made of silver, needle crystals may form on the electrodes in an ambience containing sulfur compounds.

9 Storage

- (1) Do not store and use capacitors in the following environment. Water or salt water splashes, dew wets or toxic gasses (hydrogen sulfide, sulfurous acid,chlorine, ammonium) fills, Vibration or mechanical shock exceeding the limits prescribed in the catalog or product specifications.
- (2) Do not store capacitors in places that direct sunlight pours down or dewy places.
- (3) Avoid high temperature and humidity.

The storage conditions should be : Temperature=Lower than 40℃ Humidity=Lower than 70% RH



MULTILAYER CERAMIC CAPACITORS PRECAUTIONS AND GUIDELINES

10 About AEC-Q200

The Automotive Electronics Council (AEC) was originally established by American major automotive manufactures. Today, the committees are composed of representatives from the sustaining Members of manufacturing companies in automotive electrical components. It has standardized the criteria for "stress test qualification" and "reliability test" for the electronic components.

AEC-Q200 is the reliability test standard for approval of passive components, it has been specified test subjects and quantity etc. for each components. Criteria of reliability tests such as our main products "Multilayer Ceramic Capacitors" are also described in this.

As customer requirement, Chemi-Con has submits the test results according to AEC-Q200 for the Multilayer Ceramic Capacitors used in automotive applications to increase in recent years.

AEC-Q200 compliant product is the product which we evaluated by AEC-Q200 standard.

Please contact us for more information.

Please obtain and verify our product specification sheet before you use our product.

11 Catalogs

Product specifications in this catalog are subject to change without notice.

Please request and make sure our product specifications before purchase and/or use.

12 Response to the Substances of Concern

- (1) Nippon Chemi-Con aims for developing products that meet laws and regulations concerning substances of concern. (Some products may contain regulated substances for exempted application.) Please contact us for more information about law-compliance status.
- (2) According to the content of REACH handbook (Guidance on requirements for substances in articles which is published on May 2008), our electronic components are "articles without any intended release". Therefore they are not applicable for "Registration" for EU REACH Regulation Article 7 (1).

Reference: Electrolytic Condenser Investigation Society

"Study of REACH Regulation in EU about Electrolytic Capacitor" (publicized on 13 March 2008)

For the details, refer to Guideline of notabilia for fixed multilayer ceramic capacitors for use in electronic equipment, EIAJ RCR-2335 issued by Electronic Industries Association of Japan.

Product specifications in this catalog are subject to change without notice. Request our product specifications before purchase and/or use. Please use our products based on the information contained in this catalog and product specifications 11

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PRECAUTIONS AND GUIDELINES

STANDARDIZATION

The following series were discontinued. Please use the replacements in the table.

♦ MULTILAYER CERAMIC CHIP CAPACITORS

Discontinued series	Characteristics	Replacements	Page
TCCS	Y5U, Termination (Tin Plating)	NTS	13
TCCR	Y5U, Termination (Silver)	NTS	13
THCS	Y5U, Termination (Tin Plating), Down sized	NTS	13
THCR	Y5U, Termination (Silver), Down sized	NTS	13
TMCS	Y5U, Termination (Tin Plating), High Reliability	NTF	13

♦ METAL CAP TYPE MULTILAYER CERAMIC CAPACITORS

Discontinued series	Characteristics	Replacements	Page
TCP	Y5U	NTJ	22
THP	Y5U, Down sized	NTJ	22
TMP	Y5U, Down sized, High Reliability	NTJ	22

♦ DIPPED RADIAL LEAD MULTILAYER CERAMIC CAPACITORS

Discontinued series	Characteristics	Replacements	Page
TCD	Y5U	NTD	25
THD	Y5U, Down sized	NTD	25

Lead oxides are included as a dielectric material in the discontinued series (Y5U characteristics) on the above lists. Under RoHS directive, such Lead (Pb) was already restricted from January 1, 2013. Under ELV directive, it is restricted from January 1, 2016.

Please use the replacements which are RoHS compliant.

CAT. No. E1002X Ver.4



NTS Series / NTF Series

Temperature cycle: 1000 cycles

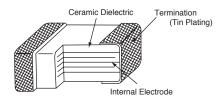
◆FEATURES

- 1. Large capacitance by small size.
- 2. Excellent noise absorption.
- 3. High permissible ripple current capability.
- 4. NTF: Temperature cycle: 1000 cycles.

APPLICATIONS

- 1. Smoothing circuit of DC-DC converters.
- 2. On-board power supplies.
- 3. Voltage regulators for computers.
- 3. Noise suppressor for various kinds of equipments.
- 4. High reliability equipments.

◆CONSTRUCTION



◆RATINGS

Category Temperature Range	-55 to +125℃
2. Rated Voltage Range	25, 35, 50, 100, 250, 500Vdc
3. Rated Capacitance Range	0.010 to 47μF
4. Rated Capacitance Tolerance	M (±20%) : Standard, K (±10%)
5. Temperature Characteristics	X7R
6. Rated Ripple Current	See No.5 on the following table

SPECIFICATIONS

No.	Items	Specification		Test C	Condition		
1	Withstand Voltage	No abnormality.	Less the More that Less that More the		Withstand voltage 250% of rated voltage 100V + 150% of rated voltage 130% of rated voltage onds.		
2	Insulation Resistance	100/C _R (MΩ) or 4000(MΩ) whichever is less.		tted voltage shall be applied for 60±5 seconds at nperature 25±2℃.			
3	Rated Capacitance	Within specified tolerance.	Temperature	Cr≦10μF	C _R >10μF		
4	Dissipation Factor	5.0% maximum.	Frequency Voltage	1±0.1kHz 1±0.2Vrm	120±12Hz s 0.5±0.2Vrms		
5	Rated Ripple Current	See STANDARD RATINGS		z (sine curve) e Vp shall be le age.	ss than		

As customer requirement, Chemi-Con has submits the test results according to AEC-Q200 for Multilayer ceramic capacitors. Please contact us for more information.





NTS_{Series} / NTF_{Series}

♦SPECIFICATIONS

No.	Items	Specification	Test Condition
6	Adhesion	No visible damage.	Substrate 5N (0.51kgf) for 10±1 seconds Capacitor
7	Bend strength of the face plating	Appearance : No visible damage. ΔC/C : ±15%	The substrate shall be bend at a rate of 1mm/s for 5 seconds. Press Press bar Capacitor Substrate Bending capability* *Bending capability NTS: 1mm NTF: 1mm or 2mm
8	Solderability	Min. 75% of surface of the termination shall be covered with new solder	Solder Pb Free Solder Temperature 245±5℃ Dipping Time 2±0.5sec.
9	Resistance to Soldering Heat	Appearance : No visible damage. $\Delta \text{C/C}: \pm 15\%$ D.F. : To meet the initial specification. I.R. : To meet the initial specification.	Preheating Condition: Step Temperature Time 1
10	Temperature Cycle	Appearance : No visible damage. Δ C/C : \pm 15% D.F. : To meet the initial specification. I.R. : To meet the initial specification.	Step Temperature (°C) (min.) 1 Min. Category temperature ±3 30±3 2 Room temperature 3 max. 3 Max. Category temperature ±3 30±3 4 Room temperature 3 max. For above temperature cycle. NTS: For 5 cycles NTF: For 1000 cycles
11	Humidity Load Life	Appearance : No abnormality. $\Delta C/C$: $\pm 15\%$ D.F. : 10% maximum I.R. : $25/C_R(M\Omega)$ or $1000(M\Omega)$ whichever is less.	Temperature : 40±2°C Humidity : 90 to 95%RH Voltage : Rated voltage Time : 500±2400 hours
12	Endurance	Appearance : No abnormality. Δ C/C : \pm 15% D.F. : 10% maximum I.R. : 50/CR(M Ω) or 1000(M Ω) whichever is less.	Temperature : 125±3℃ Voltage : Rated voltage Time : 1000±48/0 hours

*CR : Rated Capacitance(µF)



NTS Series

STANDARD RATINGS

Rated voltage	Rated Capacitance		Dimens	ions(mm)		Maximum ripple current	Dout Name have	Taping Quantity per ree
(Vdc)	(μF)	L	w	Tmax.	а	(Arms)	Part Number	(pcs. / reel)
	1.0						KTS250B105M31N0T00	3,000
	1.5	3.2±0.2	1.6±0.2	1.8	0.5±0.3	0.3	KTS250B155M31N0T00	3,000
	2.2						KTS250B225M31N0T00	3,000
	3.3						KTS250B335M32N0T00	1,600
0.5	4.7	3.2±0.4	2.5±0.3	2.6	0.6±0.3	0.5	KTS250B475M32N0T00	1,600
25	6.8						KTS250B685M32N0T00	1,600
	10						KTS250B106M43N0T00	800
	15	4.5±0.4	3.2±0.4	2.8	0.6±0.3	1.0	KTS250B156M43N0T00	800
	22	57104	50104	2.8		0.0	KTS250B226M55N0T00	800
	33	5.7±0.4	5.0±0.4	3.0	0.8±0.5	2.0	KTS250B336M55N0T00	800
	47	7.5±0.5	6.3±0.5	4.0	1.0±0.5	3.0	KTS250B476M76N0T00	300
	1.0						KTS350B105M31N0T00	3,000
	1.5	3.2±0.2	1.6±0.2	1.8	0.5±0.3	0.3	KTS350B155M31N0T00	3,000
	2.2						KTS350B225M31N0T00	3,000
	3.3						KTS350B335M32N0T00	1,600
	4.7	3.2±0.4	2.5±0.3	2.6	0.6±0.3	0.5	KTS350B475M32N0T00	1,600
35	6.8						KTS350B685M43N0T00	800
	10	4.5±0.4	3.2±0.4	2.8	0.6±0.3	1.0	KTS350B106M43N0T00	800
	15						KTS350B156M55N0T00	800
	22	5.7±0.4	5.0±0.4	2.8	0.8±0.5	2.0	KTS350B226M55N0T00	800
	33						KTS350B336M76N0T00	300
	47	7.5±0.5	6.3±0.5	4.0	1.0±0.5	3.0	KTS350B476M76N0T00	300
	0.33						KTS500B334M31N0T00	3,000
	0.47	3.2±0.2		1.8	1.8 0.5±0.3		KTS500B354M31N0T00	3,000
	0.68		3.2±0.2 1.6±0.2			0.3	KTS500B474M31N0T00	3,000
	1.0						KTS500B004M31N0T00	3,000
	1.5						KTS500B105M31N0100 KTS500B155M32N0T00	1,600
50	2.2	3.2±0.4	2.5±0.3	2.5±0.3 2.6	0.6±0.3	0.5	KTS500B155M32N0T00	1,600
50	3.3	3.2±0.4	2.5±0.5	2.0	0.0±0.3	0.5		1,600
	4.7						KTS500B335M32N0T00 KTS500B475M43N0T00	800
	6.8	4.5±0.4	3.2±0.4	2.8	0.6±0.3	1.0		800
							KTS500B685M43N0T00	
	10 15	5.7±0.4	5.0±0.4	2.8	0.8±0.5	2.0	KTS500B106M55N0T00	800 800
	22	7.5±0.5	6.3±0.5	4.0	1.0±0.5	3.0	KTS500B156M55N0T00	
		7.5±0.5	0.3±0.5	4.0	1.0±0.5	3.0	KTS500B226M76N0T00	300
	0.1						KTS101B104M31N0T00	3,000
	0.15						KTS101B154M31N0T00	3,000
	0.22	3.2±0.2	1.6±0.2	1.8	0.5±0.3	0.3	KTS101B224M31N0T00	3,000
	0.33						KTS101B334M31N0T00	3,000
	0.47						KTS101B474M31N0T00	3,000
	0.68						KTS101B684M31N0T00	3,000
400	1.0	00104	0.510.0	0.0	0.010.0	0.5	KTS101B105M32N0T00	1,600
100	1.5	3.2±0.4	2.5±0.3	2.6	0.6±0.3	0.5	KTS101B155M32N0T00	1,600
	2.2						KTS101B225M32N0T00	1,600
	1.5	4.5±0.4	3.2±0.4	۱			KTS101B155M43N0T00	800
	2.2			2.8	0.6±0.3	1.0	KTS101B225M43N0T00	800
	3.3		3.2±0.5	- 20	-		KTS101B335M43J0T00	800
	4.7			3.2			KTS101B475M43E0T00	800
	3.3		50/5:	2.8			KTS101B335M55N0T00	800
	4.7	5.7±0.4	5.0±0.4		0.8±0.5	2.0	KTS101B475M55N0T00	800
	6.8	7.5	00/5-	3.2	10:55		KTS101B685M55F0T00	800
	6.8	7.5±0.5	6.3±0.5	3.5	1.0±0.5	3.0	KTS101B685M76N0T00	300

^{**}Please consult with us when you consider the rating other than a standard table.

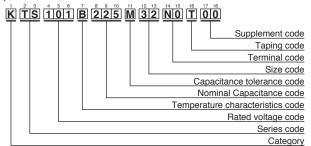


STANDARD RATINGS

Rated voltage	Rated Capacitance		Dimens	ions(mm)		Maximum ripple current	Doub November	Taping Quantity per reel
(Vdc)	(μ F)	L	W	Tmax.	а	(Arms)	Part Number	(pcs. / reel)
	0.01						KTS251B103M31N0T00	3,000
	0.022						KTS251B223M31N0T00	3,000
	0.033	3.2±0.2	1.6±0.2	1.8	0.5±0.3	0.3	KTS251B333M31N0T00	3,000
	0.047	0.2_0.2	1.0=0.2	1.0	0.0=0.0	0.0	KTS251B473M31N0T00	3,000
	0.068						KTS251B683M31N0T00	3,000
	0.1						KTS251B104M31N0T00	3,000
250	0.15	3.2±0.4		2.6		0.5	KTS251B154M32N0T00	1,600
200	0.22		2.5±0.3		0.6±0.3		KTS251B224M32N0T00	1,600
	0.33						KTS251B334M32N0T00	1,600
	0.47	4.5±0.4	3.2±0.4	2.8	0.6±0.3	1.0	KTS251B474M43N0T00	800
	0.68	1.0 = 0.1	0.2 =0.1		0.0=0.0	1.0	KTS251B684M43N0T00	800
	1.0	5.7±0.4	5.0±0.4	2.8	0.8±0.5	2.0	KTS251B105M55N0T00	800
	1.5	0.7 = 0.1	0.0 -0.1		0.0 = 0.0	2.0	KTS251B155M55N0T00	800
	1.5	7.5±0.5	6.3±0.5	3.5	1.0±0.5	3.0	KTS251B155M76N0T00	300
	2.2	7.0-0.0	0.0 = 0.0	5.0	1.0 = 0.0	0.0	KTS251B225M76N0T00	300
	0.47	5.7±0.4	5.0±0.4	2.7	0.8±0.5	1.5	KTS501B474M55N0T00	800
	0.56	5 20. 1	0.020.7	3.0	0.020.0		KTS501B564M55N0T00	800
500	0.68			2.5			KTS501B684M76N0T00	500
	1.0	7.5±0.5	6.3±0.5	3.2	1.0±0.5	2.0	KTS501B105M76N0T00	300
	1.2			3.5			KTS501B125M76N0T00	300

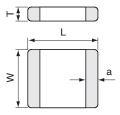
^{**}Please consult with us when you consider the rating other than a standard table.

◆PART NUMBERING SYSTEM



DIMENSIONS

Size Code								
Co	de							
JIS	EIA							
3216	1206							
3225	1210							
4532	1812							
5750	2220							
7563	3025							
	JIS 3216 3225 4532 5750							



Please refer to "Part Numbering System" of the beginning of a catalog for the details.





STANDARD RATINGS

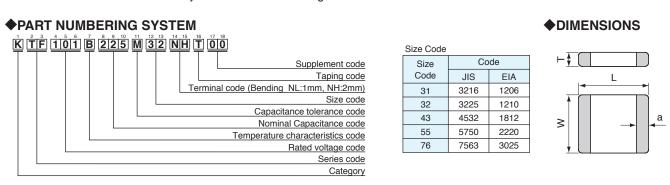
Rated voltage	Rated Capacitance		Dimens	ions(mm)		Maximum ripple current (Arms)	Part Number	Taping Quantity per ree
(Vdc)	(μ F)	L	w	Tmax.	а			(pcs. / reel)
25	1.0	3.2±0.3					KTF250B105M31NLT00	3,000
	1.5		1.6±0.2	1.8	0.7±0.2	0.3	KTF250B155M31NLT00	3,000
	2.2						KTF250B225M31NLT00	3,000
	3.3						KTF250B335M32NHT00	1,600
	4.7	3.2±0.4	2.5±0.3	2.6	0.7±0.2	0.5	KTF250B475M32NHT00	1,600
25	6.8						KTF250B685M32NHT00	1,600
	10	4.5±0.4	3.2±0.4	2.8	0.7±0.2	1.0	KTF250B106M43NHT00	800
	15	4.5±0.4	3.2±0.4	2.0	0.7±0.2	1.0	KTF250B156M43NHT00	800
	22	5.7±0.4	5.0±0.4	2.8	1.0±0.4	2.0	KTF250B226M55NHT00	800
	33	5.7±0.4	5.0±0.4	3.0	1.0±0.4	2.0	KTF250B336M55NHT00	800
	1.0						KTF350B105M31NLT00	3,000
	1.5	3.2 ± 0.3	1.6±0.2	1.8	0.7±0.2	0.3	KTF350B155M31NLT00	3,000
	2.2						KTF350B225M31NLT00	3,000
	3.3	3.2±0.4	0.540.0	2.6	0.740.0	٥٦	KTF350B335M32NHT00	1,600
35	4.7	3.2±0.4	2.5±0.3	2.0	0.7±0.2	0.5	KTF350B475M32NHT00	1,600
	6.8	4.5-0.4	3.2±0.4	0.0	0.7±0.2	1.0	KTF350B685M43NHT00	800
	10	4.5±0.4	3.2±0.4	2.8	0.7±0.2	1.0	KTF350B106M43NHT00	800
	15	57104	50104	0.0	4.010.4	0.0	KTF350B156M55NHT00	800
	22	5.7±0.4	5.0±0.4	2.8	1.0±0.4	2.0	KTF350B226M55NHT00	800
	0.33	3.2±0.3		1.8	0.7±0.2	0.3	KTF500B334M31NLT00	3,000
	0.47		1.6±0.2				KTF500B474M31NLT00	3,000
	0.68						KTF500B684M31NLT00	3,000
	1.0						KTF500B105M31NLT00	3,000
	1.5	3.2±0.4	3.2±0.4 2.5±0.3	2.6	0.7±0.2	0.5	KTF500B155M32NHT00	1,600
50	2.2						KTF500B225M32NHT00	1,600
	3.3						KTF500B335M32NHT00	1,600
	4.7	4.5±0.4	3.2±0.4	2.8	0.7±0.2	1.0	KTF500B475M43NHT00	800
	6.8	4.5±0.4	3.2±0.4	2.0	0.7±0.2	1.0	KTF500B685M43NHT00	800
	10	5.7±0.4	5.0±0.4	2.8	1.0±0.4	2.0	KTF500B106M55NHT00	800
	15	5.7±0.4	5.0±0.4	2.0	1.0±0.4	2.0	KTF500B156M55NHT00	800
	0.1						KTF101B104M31NLT00	3,000
	0.15						KTF101B154M31NLT00	3,000
	0.22	3.2±0.3	1.6±0.2	1.8	0.7±0.2	0.3	KTF101B224M31NLT00	3,000
	0.33	3.210.3	1.0±0.2	1.0	0.7±0.2	0.5	KTF101B334M31NLT00	3,000
	0.47						KTF101B474M31NLT00	3,000
	0.68						KTF101B684M31NLT00	3,000
	1.0						KTF101B105M32NHT00	1,600
100	1.5	3.2±0.4	2.5±0.3	2.6	0.7±0.2	0.5	KTF101B155M32NHT00	1,600
	2.2						KTF101B225M32NHT00	1,600
	1.5		3.2±0.4				KTF101B155M43NHT00	800
	2.2	4.5±0.4	0.2.0.4	2.8	0.7±0.2	1.0	KTF101B225M43NHT00	800
	3.3	4.5-0.4	3.2±0.5		0.7.0.2	1.0	KTF101B335M43JHT00	800
	4.7		0.2.0.3	3.2			KTF101B475M43EHT00	800
	4.7	5.7±0.4	5.0±0.4	2.8	1.0±0.4	2.0	KTF101B475M55NHT00	800
	6.8	J.7±0.4	J.U±0.4	3.2	1.0.0.4	2.0	KTF101B685M55FHT00	800





	0.033		1.6±0.2	4.0	0.7±0.2	0.3	KTF251B333M31NLT00	3,000
	0.047	3.2±0.3					KTF251B473M31NLT00	3,000
	0.068	3.2±0.3	1.0±0.2	1.8	0.7±0.2	0.5	KTF251B683M31NLT00	3,000
	0.1						KTF251B104M31NLT00	3,000
	0.15						KTF251B154M32NLT00	1,600
250	0.22	3.2±0.4	2.5±0.3	2.6	0.7±0.2	0.5	KTF251B224M32NLT00	1,600
	0.33						KTF251B334M32NLT00	1,600
	0.47	4.5±0.4	0.4 3.2±0.4	2.8	0.7±0.2	1.0	KTF251B474M43NLT00	800
	0.68	4.5±0.4	3.2±0.4			1.0	KTF251B684M43NLT00	800
	1.0	5.7±0.4	5.0±0.4	2.8	1.0±0.4	2.0	KTF251B105M55NLT00	800
	1.5	5.7±0.4	5.0±0.4		1.0±0.4	2.0	KTF251B155M55NLT00	800
500	0.47	5.7±0.4	5.0±0.4	2.7	1.0±0.4	1.5	KTF501B474M55NLT00	800
500	0.56	3.7 ±0.4		3.0		1.5	KTF501B564M55NLT00	800

^{*}Please consult with us when you consider the rating other than a standard table.



Please refer to "Part Numbering System" of the beginning of a catalog for the details.











Temperature cycle: 1000 cycles

♦FEATURES

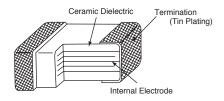
- 1. Temperature range : -55 to +150 $^{\circ}\text{C}$ 2. Temperature characteristics: X8L
- 3. Exellent noise absorption.
- 4. Automotive grade (AEC-Q200)

APPLICATIONS

- 1. Noise filter for automotive equipment (ECU etc.)
- 2. Equipment used in a high temperature environment



◆CONSTRUCTION



◆RATINGS

Category Temperature Range	-55∼+150°C
Rated Voltage Range	25, 50, 100 Vdc
Rated Capacitance Range	0.033~15μF
· · · · · · · · · · · · · · · · · · ·	M(±20%)
4. Rated Capacitance Tolerance	
5. Temperature Characteristics	X8L
Rated Ripple Current	See No.5 on the following table

SPECIFICATIONS

No.	Items	Specification	Test Condition			
1	Withstand Voltage	No abnormality.	250% of rated voltage shall be applied for 5 seconds. (Only 250Vdc product : 475V)			
2	Insulation Resistance	100/C _R (MΩ) or 4000(MΩ) whichever is less.	Rated voltage shall be applied for 60±5 seconds at temperature 25±2℃.			
3	Rated Capacitance	Within specified tolerance.		Cr≦10µF	Cr>10µF	
			Temperature	25 1	=2℃	
4	Dissipation Factor	5.0% maximum.	Frequency	1±0.1kHz	120±12Hz	
			Voltage	1±0.2Vrms	0.5±0.2Vrms	
5	Rated Ripple Current	Size code 31 32 43 55 Arms 0.3 0.5 1.0 2.0	10kHz~1MHz (sine curve) Ripple voltage Vp shall be less than the rated voltage. The surface temperature MLCC must not exceed the maximum category temperature when the ripple curren is applied.			

As customer requirement, Chemi-Con has submits the test results according to AEC-Q200 for Multilayer ceramic capacitors. Please contact us for more information.





SPECIFICATIONS

No.	Items	Specification	Test Condition				
6	High Temperature Exposure (Storage)	Appearance : No abnormality. $\Delta \text{C/C}$: $\pm 20\%$ D.F. : 10% maximum I.R. : $50/\text{Cr}(\text{M}\Omega)$ or $1000(\text{M}\Omega)$ whichever is less.		ature : Max. category temperatui 1000 ± 48 hours	re±3°C		
7	Temperature Cycle	Appearance : No visible damage. $\Delta \text{C/C}$: $\pm 15\%$ D.F. : To meet the initial specification. I.R. : To meet the initial specification.		Temperature (°C) Min.Category temperature ±3 Room temperature ±3 Room temperature resin PCB t=1.6mm) 0 cycles	(min.) 30±3 3 max. 30±3 3 max.		
8	Biased Humidity	Appearance : No abnormality. $\Delta C/C$: $\pm 20\%$ D.F. : 10% maximum I.R. : $25/C_R(M\Omega)$ or $1000(M\Omega)$ whichever is less.	Humidit Voltage	ature: 85°C±3°C y: 80 ~ 85%RH : Rated voltage 1000 ± ⁴⁸ hours			
9	Operational Life	Appearance : No abnormality. $\Delta C/C$: $\pm 20\%$ D.F. : 10% maximum I.R. : $50/C_R(M\Omega)$ or $1000(M\Omega)$ whichever is less.	Temperature: Max. category temperature ±3°C Voltage: Rated voltage Time: 1000 ± 48 hours				
10	Mechanical Shock	Appearance : No abnormality. $\Delta \text{C/C}$: To meet the initial specification. D.F. : To meet the initial specification.	MIL-STD-202 Method213 Condition F Peak value: 1,500 G Normal duration: 0.5 ms Velocity change: 15.4 ft/sec (4.7m/s) Direction and time: 3 times each in X,Y, Z axis. Total 18 times				
11	Resistance to Soldering Heat	Appearance : No visible damage. $\Delta C/C$: $\pm 15\%$ D.F. : To meet the initial specification. I.R. : To meet the initial specification.	Preheating temperature: 150±10°C Preheating time: 1 to 2 minute Solder temp.: 260±5°C Dipping Time: 10±1s				
12	ESD	Appearance: No abnormality. ΔC/C: To meet the initial specification. D.F.: To meet the initial specification. I.R.: To meet the initial specification.	Connec Direct C	200-002 tion: Between terminals contact: 8kV (150pF 2000 Ω) ±1time			
13	Solderability	Min. 75% of surface of the termination shall be covered with new solder.	5	SolderPb FreeSolder Temperature $245 \pm 5^{\circ}$ 0Dipping Time 2 ± 0.5 s	С		
14	Board Flex	Appearance : No visible damage. $\Delta \text{C/C}: \pm 15\%$	The substrate shall be bend at rate of 1mm/s for 5 seconds. Press Press bar Capacitor Substrate Bending capability* * Bending capability: 1mm or 2mm				
15	Terminal Strength (SMD)	No visible damage.		Substr 17.7N	seconds		

*CR : Rated Capacitance(µF)



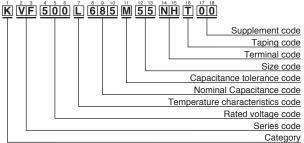


STANDARD RATINGS

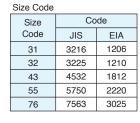
Rated voltage	Rated Capacitance		Dimensi	ons(mm)		Maximum ripple current	Part Number	Taping Quantity per reel
(Vdc)	(μ F)	L	W	T max.	а	(Arms)		(pcs. / reel)
	0.33			1.8	0.7±0.2		KVF250L334M31NLT00	3,000
	0.47	3.2±0.3	1.6±0.2			0.3	KVF250L474M31NLT00	3,000
	0.68	3.2±0.3	1.0±0.2	1.0	0.7 ± 0.2	0.5	KVF250L684M31NLT00	3,000
	1.0						KVF250L105M31NLT00	3,000
	1.5						KVF250L155M32NHT00	1,600
25	2.2	3.2 ± 0.4	2.5±0.3	2.6	0.7±0.2	0.5	KVF250L225M32NHT00	1,600
	3.3						KVF250L335M32NHT00	1,600
	4.7	4.5±0.4	3.2±0.4	2.8	0.7±0.2	1.0	KVF250L475M43NHT00	800
	6.8	4.5 ± 0.4	3.210.4	2.0	0.7 ± 0.2	1.0	KVF250L685M43NHT00	800
	10	5.7±0.4	5.0±0.4	2.8	1.0±0.4	2.0	KVF250L106M55NHT00	800
	15	5.7 ± 0.4	5.0 ± 0.4	2.0	1.0±0.4	2.0	KVF250L156M55NHT00	800
	0.1						KVF500L104M31NLT00	3,000
	0.15	3.2±0.3			0.7±0.2	0.3	KVF500L154M31NLT00	3,000
	0.22		1.6±0.2	1.8			KVF500L224M31NLT00	3,000
	0.33						KVF500L334M31NLT00	3,000
	0.47						KVF500L474M31NLT00	3,000
50	0.68	0.68 3.2±0.4	2.5±0.3	2.6	0.7±0.2	0.5	KVF500L684M32NLT00	1,600
30	1.0	J.Z ± U.4	2.5 ± 0.5	2.0	0.7 ±0.2		KVF500L105M32NHT00	1,600
	1.5	4.5±0.4	3.2±0.4	2.8	0.7±0.2	1.0	KVF500L155M43NHT00	800
	2.2	4.5 ± 0.4	3.2±0.4	2.0	0.7 ±0.2	1.0	KVF500L225M43NHT00	800
	3.3		5.0±0.4	2.8			KVF500L335M55NLT00	800
	4.7	5.7 ± 0.4			1.0±0.4	2.0	KVF500L475M55NHT00	800
	6.8			3.2			KVF500L685M55NHT00	800
	0.033						KVF101L333M31NLT00	3,000
	0.047	3.2±0.3	1.6±0.2	1.8	0.7±0.2	0.3	KVF101L473M31NLT00	3,000
	0.068	0.2 ± 0.0	1.0 ± 0.2	1.0	0.7 ± 0.2	0.5	KVF101L683M31NLT00	3,000
	0.1						KVF101L104M31NLT00	3,000
	0.15						KVF101L154M32NLT00	1,600
100	0.22	3.2 ± 0.4	2.5 ± 0.3	2.6	0.7±0.2	0.5	KVF101L224M32NLT00	1,600
	0.33						KVF101L334M32NLT00	1,600
	0.47	4.5±0.4	3.2±0.4	2.8	0.7±0.2	1.0	KVF101L474M43NLT00	800
	0.68	¬.J⊥∪.4	0.2 ± 0.4	2.0	0.7 ± 0.2	1.0	KVF101L684M43NLT00	800
	1.0	5.7±0.4	5.0±0.4	2.8	1.0±0.4	2.0	KVF101L105M55NLT00	800
	1.5	J.1 ± 0.4	J.U _ U.4	2.0	1.0 ± 0.4	2.0	KVF101L155M55NLT00	800

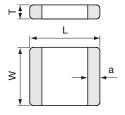
X Please consult with us when you consider the rating other than a standard table.

◆PART NUMBERING SYSTEM



♦DIMENSIONS





Please refer to "Part Numbering System" of the beginning of a catalog for the details.



METAL CAPTYPE MULTILAYER CERAMIC CAPACITORS





◆FEATURES

- 1. Small size and large capacitance, high ripple current.
- 2. Temperature cycle: 1000 cycles.
- 3. X7R temperature characteristics.
- 4. Excellent noise absorption.
- 5. For reflow soldering use.
- 6. Suitable for aluminum substrate.

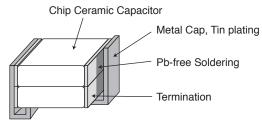
APPLICATIONS

- 1. Smoothing circuit of switching mode AC-DC or DC-DC converter.
- 2. On-board power supply.
- 3. Noise suppressor for various kinds of equipments.

♦CUSTOM MADE PRODUCTS

We can offer custom made one element metal cap type capacitors for request of customers. Please contact us if you have questions for details.

◆CONSTRUCTION



◆RATINGS

1. Category Temperature Range	-55∼+125℃
2. Rated Voltage Range	25, 35, 50, 100, 250Vdc
3. Rated Capacitance Range	1.0 to 100μF
4. Rated Capacitance Tolerance	M(±20%)
5. Temperature Characteristics	X7R
6. Rated Ripple Current	See No.5 on the following table

SPECIFICATIONS

No.	Items	Specification	Test Condition			
1	Withstand Voltage	No abnormality.	250% of rated voltage shall be applied for 5 seconds. (Only 250Vdc products : 475V)			
2	Insulation Resistance	100/Cn(M Ω) or 4000(M Ω) whichever is less.	Rated voltage shall be applied for 60±5 seconds at temperature 25±2°C.			
3	Rated Capacitance	Within specified tolerance.	Cr≦10μF Cr>10μ		Cr>10µF	
			Temperature	25±	±2℃	
4	Dissipation Factor	5.0% maximum	Frequency	1±0.1kHz	120±12Hz	
			Voltage	1±0.2Vrms	0.5±0.2Vrms	
5	Rated Ripple Current	See STANDARD RATINGS	10kHz~1MHz (sine curve) Ripple voltage Vp shall be less than the rated voltage.			

As customer requirement, Chemi-Con has submits the test results according to AEC-Q200 for Multilayer ceramic capacitors. Please contact us for more information.





METAL CAP TYPE MULTILAYER CERAMIC CAPACITORS



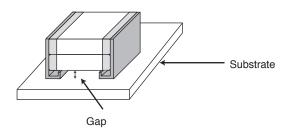
SPECIFICATIONS

No.	Items	Specification	Test Condition
6	Temperature Cycle	Appearance : No visible damage. $\Delta C/C$: $\pm 15\%$ D.F. : To meet the initial specification. I.R. : To meet the initial specification.	Step Temperature (°C) (min.) 1 Min. Category temperature ±3 30±3 2 Room temperature 3 max. 3 Max. Category temperature ±3 30±3 4 Room temperature 3 max. <cycle> 1000 cycles</cycle>
7	Humidity Load Life	Appearance : No abnormality. $\Delta C/C$: $\pm 20\%$ D.F. : 10% max. I.R. : $25/C_R(M\Omega)$ or $1000(M\Omega)$ whichever is less.	Temperature: 40±2°C Humidity: 90 to 95%RH Voltage: Rated voltage Time: 500±24 hours
8	Endurance	Appearance : No abnormality. $\Delta C/C$: $\pm 20\%$ D.F. : 10% max. I.R. : $50/C_R(M\Omega)$ or $1000(M\Omega)$ whichever is less.	Temperature : 125±3°C Voltage : Rated voltage Time : 1000± ⁴⁸ / ₀ hours

*CR: Rated Capacitance(µF)

♦Note of mountig for NTJ series.

- 1. The gap of capacitor and a substrate shall be the mounting face.
- 2. To prevent degredation of temperature cycling capability, if need to be careful about amount of solder that would not go into the inner side of terminations.





METAL CAP TYPE MULTILAYER CERAMIC CAPACITORS

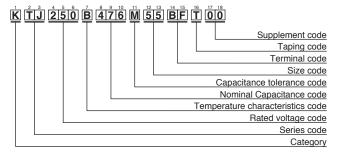


STANDARD RATINGS

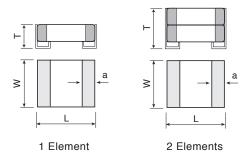
Rated voltage	Rated Capacitance		Dimens	ions(mm)		F1	Maximum ripple current	Doub Noveleau	Taping
(Vdc)	(μ F)	L	W	Tmax.	а	Element	(Arms)	Part Number	Quantity per reel (pcs. / reel)
	33	6.0±0.4	5.3±0.4	3.8	1.3±0.3	1	2.0	KTJ250B336M55AFT00	400
	33	6.0±0.4	5.3±0.4	5.5	1.3±0.3	2	3.0	KTJ250B336M55BFT00	2,000
25	47			5.5				KTJ250B476M55BFT00	2,000
	47	7.8±0.5	6.6±0.5	5.5	1.5±0.3	1	3.0	KTJ250B476M76AFT00	1,200
	68	7.8±0.5	6.6±0.5	8.5	1.5±0.3	2	4.0	KTJ250B686M76BFT00	500
	100	7.0±0.5	0.0±0.5	9.5	1.5±0.5		4.0	KTJ250B107M76BFT00	400
	33	6.0±0.4	5.3±0.4	5.5	1.3±0.3	2	3.0	KTJ350B336M55BFT00	2,000
	47	0.0±0.4	5.5±0.4	5.5	1.3±0.3	2	3.0	KTJ350B476M55BFT00	2,000
35	47	7.8±0.5	6.6±0.5	5.5	1.5±0.3	1	3.0	KTJ350B476M76AFT00	1,200
	68	7.8±0.5	6.6±0.5	8.5	1.5±0.3	2	4.0	KTJ350B686M76BFT00	500
	100	7.0±0.5	0.0±0.5	0.5	1.5±0.5		4.0	KTJ350B107M76BFT00	500
	15	6.0±0.4	5.3±0.4	3.8	1.3±0.3	1	2.0	KTJ500B156M55AFT00	400
	15	6.0±0.4	5.3±0.4	5.5	1.3±0.3	2	3.0	KTJ500B156M55BFT00	2,000
50	22	0.0±0.4	5.3±0.4	5.5	1.3±0.3		3.0	KTJ500B226M55BFT00	2,000
50	22	7.8±0.5	6.6±0.5	5.5	1.5±0.3	1	3.0	KTJ500B226M76AFT00	1,200
	33	70.05	0005	0.5	4500	0	4.0	KTJ500B336M76BFT00	500
	47	7.8±0.5	6.6±0.5	8.5	1.5±0.3	2	4.0	KTJ500B476M76BFT00	500
	4.7	6.0±0.4	5.3±0.4	3.8	1.3±0.3	1	2.0	KTJ101B475M55AFT00	400
	6.8	0.0.0.4	F 0 · 0 · 4		40.00	0	0.0	KTJ101B685M55BFT00	2,000
100	10	6.0±0.4	5.3±0.4	5.5	1.3±0.3	2	3.0	KTJ101B106M55BFT00	2,000
	6.8	7.8±0.5	6.6±0.5	5.5	1.5±0.3	1	3.0	KTJ101B685M76AFT00	1,200
	15	7.8±0.5	6.6±0.5	8.5	1.5±0.3	2	4.0	KTJ101B156M76BFT00	500
	1.0	6.0±0.4	5.3±0.4	3.8	1.3±0.3	1	2.0	KTJ251B105M55AFT00	400
	1.5	6.0±0.4	F 0 · 0 · 4	5.5	1.3±0.3	2	3.0	KTJ251B155M55BFT00	2,000
250	2.2	6.0±0.4	5.3±0.4	6.5	1 1.3±0.3	2	3.0	KTJ251B225M55BFT00	2,000
	2.2	7.8±0.5	6.6±0.5	5.5	1.5±0.3	1	3.0	KTJ251B225M76AFT00	1,200
	3.3	7.8±0.5	6.6±0.5	8.5	1.5±0.3	2	3.0	KTJ251B335M76BFT00	500

[%]Please consult with us when you consider the rating other than a standard table.

◆PART NUMBERING SYSTEM



♦DIMENSIONS



Please refer to "Part Numbering System" of the beginning of a catalog for the details.







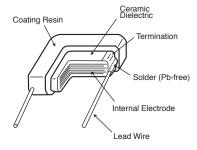
◆FEATURES

- 1. Small in size and wide capacitance range. Max. 470µF is available.
- 2. Temperature characteristic is X7R in EIA code.
- 3. Superior humidity characteristic and long life.
- 4. Excellent high frequency characteristic due to low ESR.
- 5. High rated ripple current.
- 6. 250Vdc items are available.
- 7. Resin(UL94 V-0) used for coating.
- 8. Pb-free design(also ceramic dielectric)

APPLICATIONS

- 1. Smoothing circuit of switching mode AC-DC or DC-DC converter.
- 2. Noise suppressor for various kinds of equipments.
- 3. By-pass or decoupling circuits.
- 4. Automotive equipments.

◆CONSTRUCTION



◆RATINGS

Category Temperature Range	-55 to +125℃
2. Rated Voltage Range	25, 35, 50, 100, 250, 500Vdc
3. Rated Capacitance Range	0.1 to 470µF
4. Rated Capacitance Tolerance	M(±20%)
5. Temperature Characteristics	X7R
6. Rated Ripple Current	See No.5 on the following table

SPECIFICATIONS

No.		Items	Specification		Test C	Condition	
1	Withstand Between Noltage Terminals		No abnormality.	Rated v	roltage	Withstand voltage	
		Terminals to		Less th	an 250V	250% of rated voltage	
		Coating Resin		More than 250V Less than 500V More than 500V		100V + 150% of rated voltage	
						130% of rated voltage	
				Shall be applied for 5 seconds.			
2	Insulation Re	sistance	100/C _R (MΩ) or 4000(MΩ) whichever is less.	Rated voltage shall be applied for 60±5 seconds at temperature 25±2°C.			
3	Rated Capac	itance	Within specified tolerance.	Cn≦10µF		CR>10µF	
				Temperature		25±2℃	
4	Dissipation Factor		5.0% maximum.	Frequency	1±0.1kHz	120±12Hz	
				Voltage	1±0.2Vrms	0.5±0.2Vrms	

As customer requirement, Chemi-Con has submits the test results according to AEC-Q200 for Multilayer ceramic capacitors. Please contact us for more information.







SPECIFICATIONS

No.	Items		Specification		Test C	Condition		
5	Rated Ripple	Current	See STANDARD RATINGS	,	10kHz to 1MHz (sine curve) Ripple voltage Vp shall be less than the rated voltage.			
6	Robustness	Tension	No visible damage.	The force applied sha	all be :			
	of Terminations			Lead φ (mm)	Tensil	le(N)	(sec.)	
	Terrimations			0.5 max.	5	;	10±1	
				0.6 min.	10	0	10±1	
		Bending		Lead φ (mm)	Bendir	ng(N)	(kg)	
				0.5 max.	2.	5	0.25	
				0.6 min.	5	5	0.51	
				Time : 2times.				
7	Vibration		Appearance: No abnormality. Capacitance: To meet the initial specification. D.F.: To meet the initial specification.	1	:	0Hz (1 min) . Total 6 hours.		
8	Solderability		Min. 75% of surface of the termination	Solder		Pb Fi	ee	
	,	shall be covered with new solder.		Solder Temperat	ure	245±5℃		
				Dipping Time	,	2±0.5	sec.	
9	Resistance to	Soldering Heat	Appearance: No abnormality. ΔC/C:±15% D.F.: To meet the initial specification. I.R.: To meet the initial specification.	1 1 3	: 350±10 : 3±0.5 s : 1.5 to 2	sec.		
10	Temperature (Cycle		Step Te	mperatur	re (°C)	(min.)	
			Appearance : No abnormality.	I		perature ±3	30±3	
			ΔC/C :±15%		om tempe		3 max.	
			D.F.: To meet the initial specification.	3 Max. Cate	egory tem	perature ±3	30±3	
			I.R. : To meet the initial specification.		om tempe		3 max.	
				For 5 cycles for above temperature cycle.				
11	Humidity Load Life		Appearance : No abnormality. $\Delta \text{C/C}: \pm 20\%$ D.F. : 10% maximum I.R. : 25/C _R (M Ω) or 1000(M Ω) whichever is less.	Voltage : Rated	℃ 95%RH d voltage 24 hours			
12	Endurance		Appearance : No abnormality. $\Delta C/C:\pm 20\%$ D.F. : 10% maximum I.R. : $50/C_R(M\Omega)$ or $1000(M\Omega)$ whichever is less.		3℃ I voltage ± ⁴⁸ hour	s		

*CR : Rated Capacitance(µF)





STANDARD RATINGS

Rated voltage	Rated Capacitance		Di	imensions (m	m)		Maximum	5	Taping
(Vdc)	(μ F)	Lmax.	Wmax.	Tmax.	F±0.8	φd±0.05	ripple current (Arms)	Part Number	Quantity per reel (pcs. / box)
	3.3	5.0	6.0	3.5	5.0	0.5	0.3	KTD250B335M32A0T00	2,000
	4.7	5.0	0.0	0.0	3.0	0.5	0.0	KTD250B475M32A0T00	2,000
	6.8							KTD250B685M43A0T00	2,000
	10	6.5	6.5	4.0	5.0	0.5	0.8	KTD250B106M43A0T00	2,000
	15							KTD250B156M43A0T00	2,000
	15							KTD250B156M55A0T00	2,000
	22	7.5	9.0	4.5	5.0	0.5	1.0	KTD250B226M55A0T00	2,000
25	33							KTD250B336M55A0T00	2,000
	47	10.0	11.5	5.5	5.0	0.5	1.5	KTD250B476M76A0T00	1,000
	68	13.5	15.0	6.0	10.0	0.6	2.0	KTD250B686M80A0B00	_
	100 150			8.0				KTD250B107M80A0B00	_
	220	22.5	20.0	6.0 8.0	20.0	0.8	3.0	KTD250B157M90A0B00 KTD250B227M90A0B00	_
	330			8.0				KTD250B227M90A0B00 KTD250B337M99A0B00	_
	470	28.5	20.0	11.5	25.0	0.8	4.0	KTD250B337M99A0B00 KTD250B477M99A0B00	_
	3.3			11.5				KTD350B335M32A0T00	2,000
	4.7	5.0	6.0	3.5	5.0	0.5	0.3	KTD350B475M32A0T00	2,000
	6.8							KTD350B685M43A0T00	2,000
	10	6.5	6.5	4.0	5.0	0.5	0.8	KTD350B106M43A0T00	2,000
35	15							KTD350B156M55A0T00	2,000
	22	7.5	9.0	4.5	5.0	0.5	1.0	KTD350B226M55A0T00	2,000
	33			5.0				KTD350B336M76A0T00	1,000
	47	10.0	11.5	5.5	5.0	0.5	1.5	KTD350B476M76A0T00	1,000
	1.0							KTD500B105M32A0T00	2,000
	1.5	F 0	6.0	0.5	F 0	0.5	0.0	KTD500B155M32A0T00	2,000
	2.2	5.0	6.0	3.5	5.0	0.5	0.3	KTD500B225M32A0T00	2,000
	3.3							KTD500B335M32A0T00	2,000
	4.7	6.5	6.5	4.0	5.0	0.5	0.0	KTD500B475M43A0T00	2,000
	6.8	0.5	6.5	4.0	5.0	0.5	0.8	KTD500B685M43A0T00	2,000
	10	7.5	9.0	4.5	5.0	0.5	1.0	KTD500B106M55A0T00	2,000
50	15							KTD500B156M55A0T00	2,000
	22	10.0	11.5	5.0	5.0	0.5	1.5	KTD500B226M76A0T00	1,000
	33	13.5	15.0	5.5	10.0	0.6	2.0	KTD500B336M80A0B00	_
	47			6.0				KTD500B476M90A0B00	_
	68	22.5	20.0		20.0	0.8	3.0	KTD500B686M90A0B00	_
	100			7.0				KTD500B107M90A0B00	_
	150	28.5	20.0	7.5	25.0	0.8	4.0	KTD500B157M99A0B00	
	220 0.33			10.0				KTD500B227M99A0B00 KTD101B334M32A0T00	2,000
	0.33							KTD101B334M32A0T00	2,000
	0.68							KTD101B684M32A0T00	2,000
	1.0	5.0	6.0	3.5	5.0	0.5	0.3	KTD101B004M32A0T00	2,000
	1.5							KTD101B155M32A0T00	2,000
	2.2							KTD101B105M32A0T00	2,000
	1.5							KTD101B155M43A0T00	2,000
	2.2							KTD101B225M43A0T00	2,000
	3.3	6.5	6.5	4.0	5.0	0.5	0.8	KTD101B335M43A0T00	2,000
	4.7							KTD101B475M43A0T00	2,000
100	3.3			4.5				KTD101B335M55A0T00	2,000
	4.7	7.5	9.0	4.5	5.0	0.5	1.0	KTD101B475M55A0T00	2,000
	6.8			4.7				KTD101B685M55A0T00	2,000
	6.8	10.0	11.5	5.0	5.0	0.5	1.5	KTD101B685M76A0T00	1,000
	10	13.5	15.0	5.0	10.0	0.6	2.0	KTD101B106M80A0B00	_
	15	10.0	13.0	6.0	10.0	0.0	2.0	KTD101B156M80A0B00	-
	22	22.5	20.0	6.0	20.0	0.8	3.0	KTD101B226M90A0B00	_
	33		20.0	3.0	20.0	0.0	5.0	KTD101B336M90A0B00	_
	47			7.5				KTD101B476M99A0B00	_
	68	28.5	20.0		25.0	0.8	4.0	KTD101B686M99A0B00	_
	100			9.0				KTD101B107M99A0B00	_





	0.1							KTD251B104M32A0T00	2,000
	0.15	5.0	6.0	3.5	5.0	0.5	0.3	KTD251B154M32A0T00	2,000
	0.22	5.0	6.0	3.5	5.0	0.5	0.3	KTD251B224M32A0T00	2,000
	0.33							KTD251B334M32A0T00	2,000
	0.47	6.5	6.5	4.0	5.0	0.5	0.8	KTD251B474M43A0T00	2,000
	0.68	0.5						KTD251B684M43A0T00	2,000
250	1.0	7.5	9.0	4.5	5.0	0.5	1.0	KTD251B105M55A0T00	2,000
250	1.5	7.5						KTD251B155M55A0T00	2,000
	2.2	10.0	11.5	6.0	5.0	0.5	1.5	KTD251B225M76A0T00	1,000
	2.2	13.5	15.0	5.0	10.0	0.6	2.0	KTD251B225M80A0B00	_
	3.3	22.5	20.0	6.0	20.0	0.8	3.0	KTD251B335M90A0B00	_
	4.7	22.5						KTD251B475M90A0B00	_
	6.8							KTD251B685M99A0B00	_
	10	28.5	20.0	7.5	25.0	0.8	4.0	KTD251B106M99A0B00	_
	15							KTD251B156M99A0B00	_
	0.47	7.5	9.0	3.5	5.0	0.5	0.8	KTD501B474M55A0T00	2,000
	0.56	7.5	9.0	3.5	5.0	0.5	0.0	KTD501B564M55A0T00	2,000
500	0.68	10.0	11.5	3.4	5.0	0.5	1.0	KTD501B684M76A0T00	1,500
	1.0			3.8				KTD501B105M76A0T00	1,500
	1.2			4.2				KTD501B125M76A0T00	1,500

^{*}Please consult with us when you consider the rating other than a standard table.

◆PART NUMBERING SYSTEM ◆DIMENSIONS Crimped lead Straight lead K TD 500 B 106 M 55 A0 T 00 32 to 76 Size For all size Supplement code Taping code Terminal code Size code ≥ ≥ Capacitance tolerance code Nominal Capacitance code F Temperature characteristics code Rated voltage code Series code Category

Please refer to "Part Numbering System" of the beginning of a catalog for the details.











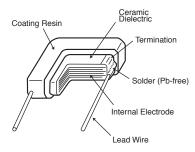
◆FEATURES

- 1. Temperature range : -55 to +150°C
- 2. Temperature characteristic: X8L
- 3. Small in size and wide capacitance range. Max. 15μ F is available.
- 4. Epoxy resin(UL94 V-0)used for coating.
- 5. Automotive grade(AEC-Q200)

APPLICATIONS

- 1. Noise fillter for automotive equipment(ECU etc.)
- 2. Equipment used in a high temperature environment

CONSTRUCTION



♦RATINGS

Category Temperature Range	-55∼+150°C
2. Rated Voltage Range	25, 50, 100 Vdc
3. Rated Capacitance Range	0.1∼15μF
4. Rated Capacitance Tolerance	M(±20%)
5. Temperature Characteristics	X8L
6. Rated Ripple Current	See No.5 on the following table

SPECIFICATIONS

No.	Items		Specification	Test Condition			
1	Withstand Between Terminals Terminals to Coating Resin		No abnormality.	250% of rated voltage shall be applied for 5 seconds. (Only 250Vdc products: 475V)			
2	2 Insulation Resistance		100/C _R (MΩ) or 4000(MΩ) whichever is less.	Rated voltage shall be applied for 60±5 seconds at temperature 25±2°C.			
3	Rated Capacitance		Within specified tolerance.		Cr≦10μF Cr>10μF		
				Temperature	25±2℃		
4	Dissipation Factor		ipation Factor 5.0% maximum.		1±0.1kHz	120±12Hz	
				Voltage	1±0.2Vrms	0.5±0.2Vrms	

As customer requirement, Chemi-Con has submits the test results according to AEC-Q200 for Multilayer ceramic capacitors. Please contact us for more information.





SPECIFICATIONS

No.	Ite	ms	Specification	Test Condition			
5	Rated Ripple	Current	Size code 32 43 55 Arms 0.3 0.8 1.0	10kHz to 1MHz (sine curve) Ripple voltage Vp shall be less than the rated voltage. The surface temperature of MLCC must not exceed the maximum category temperature when the ripple current is applied.			
6	High Temperature Exposure(Storage)		Appearance : No structural damage such as cracks $\Delta C/C$: $\pm 20\%$ D.F. : 10% maximum I.R. : $50/C_R(M\Omega)$ or $1000(M\Omega)$ whichever is less.	Temperature : Max. category temperature $\pm 3^{\circ}$ C Time : $1000 \pm {}^{48}_{0}$ hours			
7	Temperature Cycle		Appearance: No visible damage. ΔC/C: ±15% D.F.: To meet the initial specification. I.R.: To meet the initial specification.	Step Temperature(°C) (min) 1 Min Category temperature ±3 30±3 2 Room temperature 3 max. 3 Max. Category temperature ±3 30±3 4 Room temperature 3 max. For 1000 cycles			
8	Biased Humi	dity	Appearance : No abnormality. $\Delta C/C$: $\pm 20\%$ D.F. : 10% maximum I.R. : 25/C _R (M Ω) or 1000(M Ω) whichever is less.	Temperature: 85°C±3°C Humidity: 80 ~ 85%RH Voltage: Rated voltage Time: 1000 ± 48 hours			
9	Operational Life		Appearance : No structural damage such as cracks $\Delta C/C$: $\pm 20\%$ D.F. : 10% maximum I.R. : $50/C_R(M\Omega)$ or $1000(M\Omega)$ whichever is less.	Temperature : Max. category temperature $\pm 3^{\circ}$ C Voltage : Rated voltage Time : $1000 \pm {}^{48}_{0}$ hours			
10	Terminal Strength (Leaded)	Tension Bending	− No visible damage.				
11	Mechanical S	Shock	Appearance: No abnormality. ΔC/C: To meet the initial specification. D.F.: To meet the initial specification.	MIL-STD-202 Method 213 Condition C Peak value: 100G Normal duration: 6 ms Velocity change: 12.3 ft/sec(3.8m/s) Direction and time: 3 times each in X,Y, Z axis. Total 18 times			
12	Vibration		Appearance : No abnormality. ΔC/C : To meet the initial specification. D.F. : To meet the initial specification.	MIL-STD-202 Method 204 Test condition: 5G peak Amplitude: 1.5mm max. Frequency: 10-2000-10Hz(20 minute) Direction and time: 12 times each in X,Y, Z axis. Total 36 times			
13	Resistance to Soldering Heat		Appearance : No visible damage. $\Delta C/C$: $\pm 15\%$ D.F. : To meet the initial specification. I.R. : To meet the initial specification.	Solder temp.: 260±5°C Dipping Time: 10±1s Depth: 1.5 to 2mm			
14	ESD		Appearance : No abnormality. ΔC/C : To meet the initial specification. D.F. : To meet the initial specification. I.R. : To meet the initial specification.	AEC-Q200-002 Connection : Between terminals Direct Contact : $8kV(150pF\ 2000\ \Omega)$ Times : $\pm 1time$			
15	Solderability		Min. 75% of surface of the termination shall be covered with new solder.	Solder Pb Free Solder Temperature 245±5°C Dipping Time 2±0.5s			

*CR : Rated Capacitance(µF)



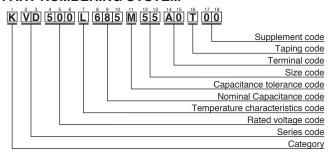


STANDARD RATINGS

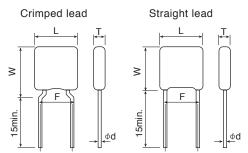
Rated voltage	Rated Capacitance (µF)	Dimensions(mm)					Maximum ripple current	Part Number	Taping Quantity per reel
(Vdc)		L max.	W max.	T max.	F±0.8	ϕ d±0.05	(Arms)		(pcs. / box)
	1.0	5.0	6.0	3.5	5.0	0.5	0.3	KVD250L105M32A0T00	2,000
	1.5							KVD250L155M32A0T00	2,000
	2.2							KVD250L225M32A0T00	2,000
25	3.3							KVD250L335M32A0T00	2,000
23	4.7	6.5	6.5	4.0	5.0	0.5	0.8	KVD250L475M43A0T00	2,000
	6.8	0.5		4.0	5.0	0.5		KVD250L685M43A0T00	2,000
	10	7.5	9.0	4.5	5.0	0.5	1.0	KVD250L106M55A0T00	2,000
	15	7.5			5.0	0.5		KVD250L156M55A0T00	2,000
	0.33	5.0	6.0	3.5	5.0	0.5	0.3	KVD500L334M32A0T00	2,000
	0.47							KVD500L474M32A0T00	2,000
	0.68							KVD500L684M32A0T00	2,000
	1.0							KVD500L105M32A0T00	2,000
50	1.5	6.5	6.5	4.0	5.0	0.5	0.8	KVD500L155M43A0T00	2,000
	2.2							KVD500L225M43A0T00	2,000
	3.3	7.5	9.0	4.5	5.0	0.5	1.0	KVD500L335M55A0T00	2,000
	4.7							KVD500L475M55A0T00	2,000
	6.8			4.7				KVD500L685M55A0T00	2,000
100	0.1	5.0	6.0	3.5	5.0	0.5	0.3	KVD101L104M32A0T00	2,000
	0.15							KVD101L154M32A0T00	2,000
	0.22							KVD101L224M32A0T00	2,000
	0.33							KVD101L334M32A0T00	2,000
	0.47	6.5	6.5	4.0	5.0	0.5	0.8	KVD101L474M43A0T00	2,000
	0.68							KVD101L684M43A0T00	2,000
	1.0	7.5	9.0	4.5	5.0	0.5	1.0	KVD101L105M55A0T00	2,000
	1.5							KVD101L155M55A0T00	2,000

X Please consult with us when you consider the rating other than a standard table.

◆PART NUMBERING SYSTEM



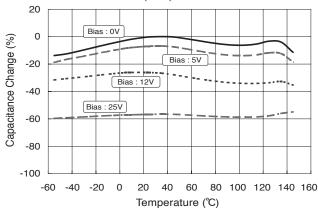
◆DIMENSIONS



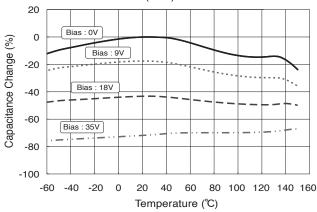
Please refer to "Part Numbering System" of the beginning of a catalog for the details.

◆Temperature and DC voltage Characteristics

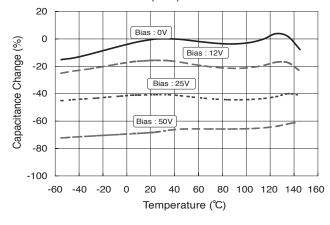
●NTS/NTF/NTD/NTJ series (X7R) 25V



●NTS/NTF/NTD/NTJ series (X7R) 35V

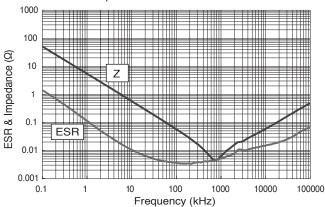


●NTS/NTF/NTD/NTJ series (X7R) 50V

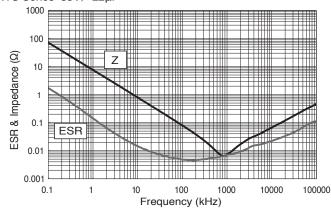


◆Frequency Characteristics

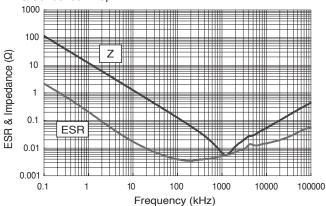
●NTS Series 25V/33µF



●NTS Series 35V / 22µF

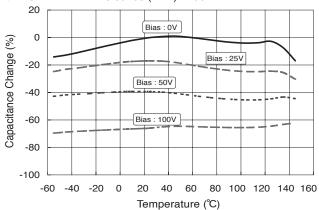


●NTS Series 50V/15µF

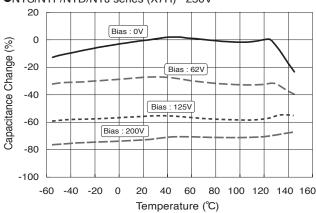


◆Temperature and DC voltage Characteristics

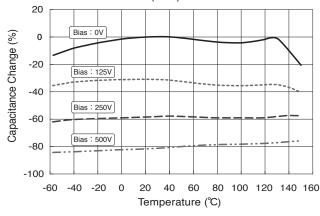
●NTS/NTF/NTD/NTJ series (X7R) 100V



●NTS/NTF/NTD/NTJ series (X7R) 250V

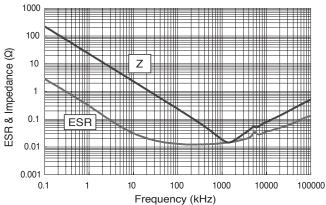


●NTS/NTF/NTD/NTJ Series (X7R) 500V

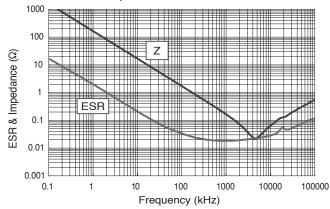


♦Frequency Characteristics

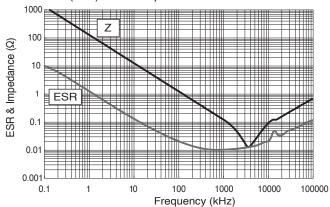
●NTS Series 100V/6.8µF



●NTS Series 250V/1.0µF

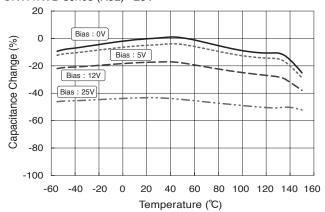


●NTS Series (X7R) 500V/1.2µF

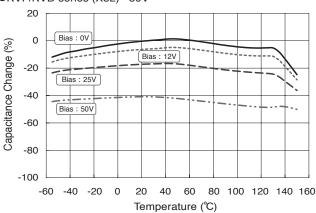


◆Temperature and DC voltage Characteristics

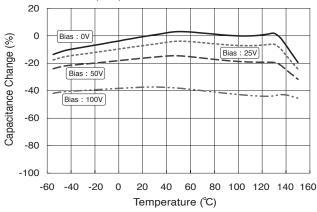
●KVF/KVD series (X8L) 25V



●KVF/KVD series (X8L) 50V

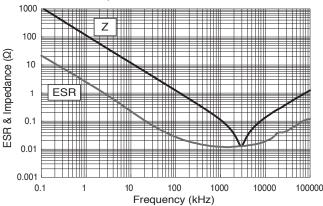


●KVF/KVD series (X8L) 100V

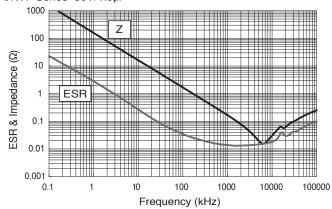


♦Frequency Characteristics

●KVF Series 25V/1.5µF



●KVF Series 50V/1.0µF



●KVF Series 100V/0.22µF

